2830 S. Fairview St. Santa Ana, CA 92704 PH: (714) 979-8220 FAX: (714) 966-5256

MX086-4

Features

- Standard spacecraft screening is per Microsemi PS11.50 "S" (no suffix letter required, MX086-4 is only "S" screened)
- Designed for battery cell bypass
- Passivated mesa structure for very low leakage currents
- 4 die stacked in one package
- Hermetically sealed, ceramic surface mount power package

60 Volts 50 Amps 2 μs

BATTERY BYPASS CHARGE DIODE

Maximum Ratings @ 25°C (unless otherwise specified)

DESCRIPTION	SYMBOL	MAX.	UNIT
Peak Repetitive Reverse Voltage (NOT A BLOCKING DIODE!)	V_{RRM}	60	Volts
Average Rectified Forward Current, Tc≤ 125°C	I _{F(ave)}	50	Amps
Nonrepetitive Peak Surge Current, tp= 8.3 ms, half-sinewave	I _{FSM}	300	Amps
Junction Temperature Range (for bypass operation)	T _j	-20 to +275	°C
Storage Temperature Range	T _{stg}	-65 to +175	°C
Thermal Resistance, Junction to Case:	$\theta_{\sf JC}$	0.9	°C/W

DESCRIPTION	SYMBOL	CONDITIONS	MIN	TYP.	MAX	UNIT
Reverse (Leakage) Current	IR	VR= 60 Vdc, Tc= 25°C		1	10	μΑ
Forward Voltage	VF1	IF= 100 mA, Tc= 25°C	2.5		3.0	V
pulse test, pw= 300 μs, d/c≤ 2%	VF2	IF= 5 A, Tc= 25°C	2.75		3.73	V
	VF3	IF = 10A, Tc= 25°C	3.2		3.86	

MARK: CATHODE DOT USE BLACK INK ALLOY 42, Ni PLATE 2 PLACES MARK: SER# USE BLACK INK 0.325±.010